

RoHS

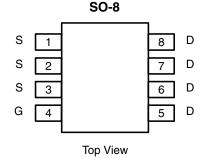
COMPLIANT

HALOGEN FREE

Vishay Siliconix

N-Channel 30 V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY I_D (A)^a V_{DS} (V) $R_{DS(on)}(\Omega)$ Q_g (Typ.) 0.0095 at V_{GS} = 10 V 16 30 9.5 nC 0.0120 at V_{GS} = 4.5 V 15

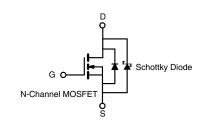


FEATURES

- Halogen-free According to IEC 61249-2-21 • Definition
- SkyFET[®] Monolithic TrenchFET[®] Gen. III Power MOSFET and Schottky Diode
- 100 % R_g Tested 100 % UIS Tested
- ٠
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Notebook PC - System Power, Memory
- **Buck Converter**
- Synchronous Rectifier Switch



Ordering Information:

Si4774DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	30	v		
Gate-Source Voltage	V _{GS}	± 20	v		
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C		16		
	T _C = 70 °C		13.6		
	T _A = 25 °C	I _D	12 ^{b, c}		
	T _A = 70 °C		9.6 ^{b, c}		
Pulsed Drain Current (t = 300 μs)	I _{DM}	50	A		
Continuous Source-Drain Diode Current	T _C = 25 °C	-	4.5	-	
	T _A = 25 °C	I _S –	2.3 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	15		
Single Pulse Avalanche Energy		E _{AS}	11.25	mJ	
Maximum Power Dissipation	T _C = 25 °C		5	1	
	T _C = 70 °C	Б	3.2	w	
	T _A = 25 °C	P _D	2.5 ^{b, c}		
	T _A = 70 °C	-	1.6 ^{b, c}	1	
Operating Junction and Storage Temperature Range	T _J , T _{stq}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Тур.	Max.	Unit	
Maximum Junction- to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	38	50	°C/W	
Maximum Junction- to-Foot (Drain)	Steady State	R _{thJF}	20	25	°C/W	

Notes:

a. Based on T_C = 25 °C. b. Surface mounted on 1" x 1" FR4 board. c. t = 10 s.

d. Maximum under steady state conditions is 85 °C/W.

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Si4774DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0, I_D = 1 \text{ mA}$	30				
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	1 2.3		V		
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$		0.028	0.200	mA	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 100 ^{\circ}\text{C}$		2.5	20		
On -State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
	Б	V _{GS} = 10 V, I _D = 10 A		0.0079	0.0095	<u> </u>	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$		0.0096	0.0120	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		43		S	
Dynamic ^b		· · · · · ·					
Input Capacitance	C _{iss}			1025		pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		251			
Reverse Transfer Capacitance	C _{rss}			100			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		20.3	30.5	nC	
				9.5	14.3		
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		2.8			
Gate-Drain Charge	Q _{gd}			3.2			
Gate Resistance	R _g	f = 1 MHz	0.3	1.0	2.0	Ω	
Turn-On Delay Time	t _{d(on)}			11	22		
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		22	48		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		13	26		
Fall Time	t _f			11	22		
Turn-On Delay Time	t _{d(on)}			8	16	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		13	26		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		14	28		
Fall Time	t _f			9	18		
Drain-Source Body Diode and Schottky	Characterist	ics					
Continuous Source-Drain Diode Current	ا _S	$T_{\rm C} = 25 {\rm ^{\circ}C}$			4.5	А	
Pulse Diode Forward Current ^a	I _{SM}				50	A	
Body Diode Voltage	V _{SD}	I _S = 2 A		0.44	0.55	V	
Body Diode Reverse Recovery Time	t _{rr}			18	35	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 5 A, dl/dt = 100 A/μs, T _{.1} = 25 °C		7.5	15	nC	
Reverse Recovery Fall Time	t _a	$F = 3 A$, $u/ut = 100 A/\mu s$, $T_{J} = 25 C$		10		- ns	
Reverse Recovery Rise Time	t _b	1 1		8			

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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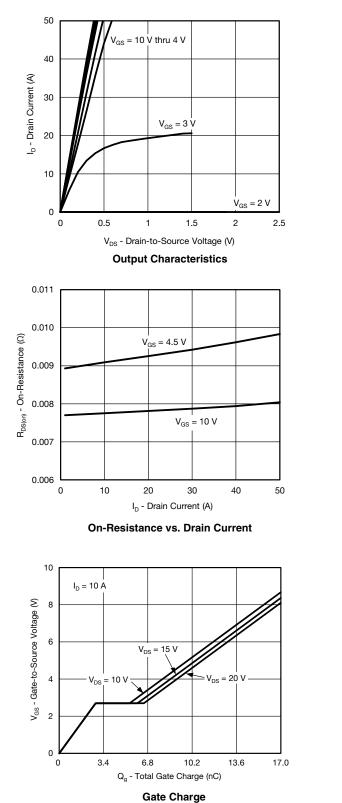
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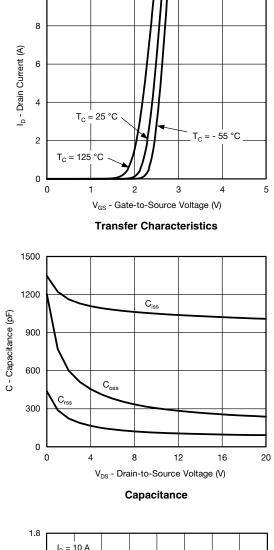
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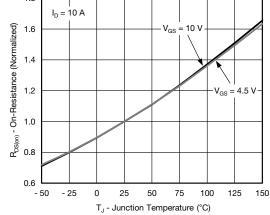


Si4774DY Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







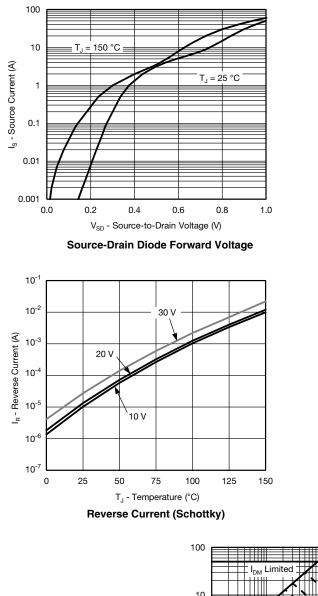
On-Resistance vs. Junction Temperature

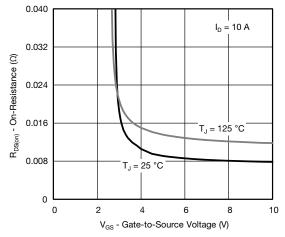
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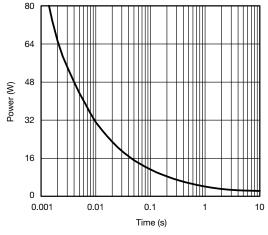


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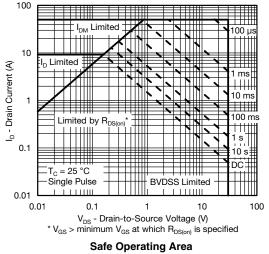




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



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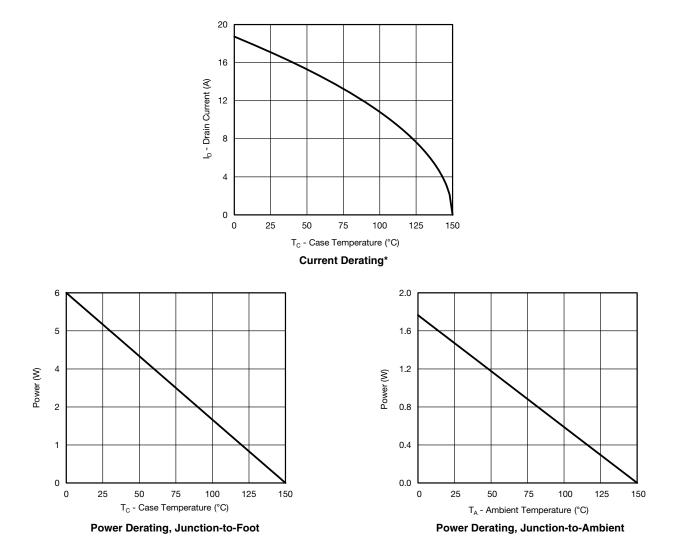
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



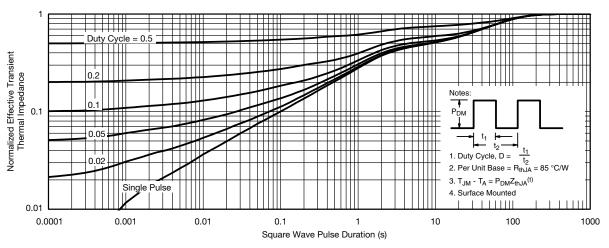
* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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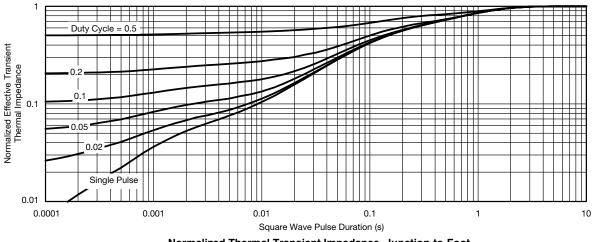
Vishay Siliconix



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67953.

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Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





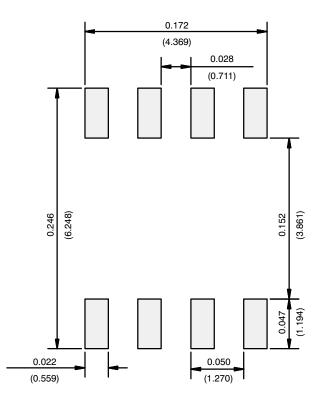
	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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